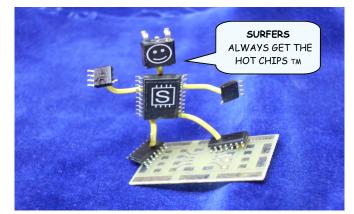


WE MAKE BREADBOARDING EASY

Capital has been providing interconnect solutions for over 25 years. Our popular **SURFBOARDS** have been making Surface Mount technology easy and accessible to engineers, enthusiasts, and educators for over 15 years. Our patented* Universal Pad features greatly extend layout and component mounting options and can provide a more compact prototype with shorter more direct connections to peripheral components and devices. Simple hand soldering tools are often all that are needed to create prototypes with a wide range of components. See Bulletin **SM-EZ-101** for more information.

Capitals breadboards, adapters, and interconnect products can extend the classical breadboarding concept to Surface Mount as well as streamline the process by providing the perfect medium between the two worlds, often with better performance and lower cost.

In addition to standard products, Capital also offers a range of custom interconnect and manufacturing solutions from prototype to production. See the Menu for a partial listing of our board level products.



MENU ITEMS SERVED WITH YOUR CHOICE OF: GREENSURF TM RoHS Lead Free Finish. PitchGREEN TM RoHS compliant process. Traditional Lead based Technologies Available.

MENU

SURFBOARDS ®

Surface Mount breadboards and adaptors. The original Surface Mount universal board. BUILDING BLOCKS FOR SURFACE MOUNT[™]

UNI-SIP TM

Miniature breadboard modules for through hole components feature Single-In-Line pins on .100 in. centers.

BREAD*STIX* TM

Segmented breadboard strips can be user defined. Models feature both standard and universal patterns

SCOREBOARD M

Larger form factor breadboards feature scores (breaklines) on grid that permit the user to define breadboard of desired size.

SCORECARD TM

Smaller form factor breadboards feature scores (breaklines) and both standard and universal patterns.

CARGO-CHIP TM

Custom Circuit Modules packaged in small form factor feature surface mount technology.

CARGO-DIP \mathbb{T} Custom circuit modules in DIP (dual-in-line) format.

CARGO-SIP $\[mathbb{TM}\]$ Custom Circuit modules in SIP (single-in-line) format.

PitchPATCH 114

Convert one pitch to another. Surface Mount to Dip. Surface Mount to Surface Mount.

ProtoPATCH TM

Application specific circuit configurations extend breadboard versatility.

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